

SF1081A

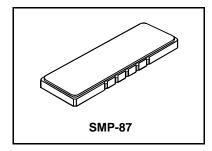
- Designed for GSM BTS Receiver IF Applications
- Simple External Impedance Matching
- Hermetic SMP-87 Surface-Mount Case
- Unbalanced Input and Output
- Indoor-Temperature Version of SF1081A-1
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

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Rating	Value	Units			
Maximum Incident Power in Passband	+10	dBm			
Max. DC voltage between any 2 terminals	30	VDC			
Storage Temperature Range	-40 to +85	°C			
Suitable for lead-free soldering - Max Soldering Profile	260°C	260°C for 30 s			

71.00 MHz **SAW Filter**



Electrical Characteristics

Characteristic		Sym	Notes	Min	Тур	Max	Units
Nominal Center F	requency	f _C	4		71.000	•	MHz
Passband	Insertion Loss at fc	IL	-		6	8.0	dB
	3 dB Passband	BW ₃		±100	±140	±200	kHz
	Amplitude Ripple over fc±80 kHz		1.2			1.5	dB _{P-P}
	Group Delay Variation over fc±50 kHz	GDV	1, 2		300	1000	ns _{P-P}
	Absolute Group Delay	GD			2.8		μs
Rejection	fc-600 to fc-400 and fc+400 to fc+600 kHz			25	26		dB
	fc-1.0 to fc-0.6 and fc+0.6 to fc+1.8 MHz		1 2 2	35	40		
	69.6 to 70.0 MHz		1, 2, 3	40	45		
	31 to 69.6 and 71.8 to 111 MHz			35	50		
Operating Temperature Range		T _A	1	-5		+70	°C

Impedance Matching to 50 Ω unbalanced	External L-C		
Case Style	SMP-87 22.1 X 8 mm Nominal Footprint		
Lid Symbolization (YY=year, WW=week)	RFM SF1081A YYWW		

Electrical Connections

Connection	Terminals
Port 1Hot	1
Port 1 Gnd Return	10
Port 2 Hot	6
Port 2 Gnd Return	5
Case Ground	All Others

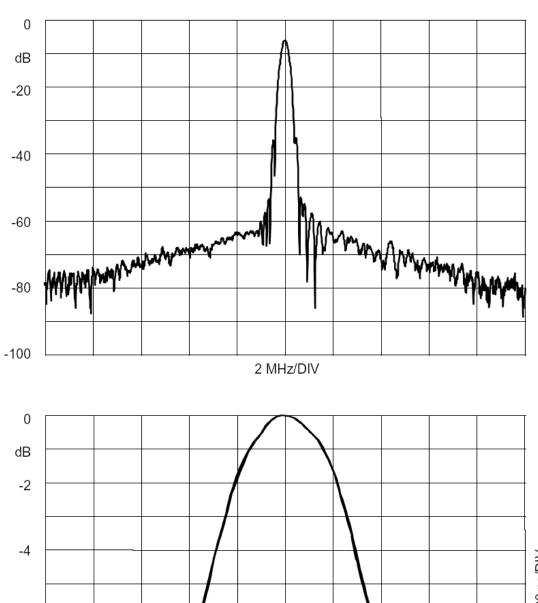


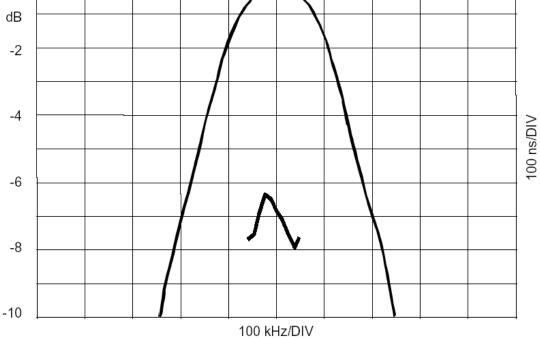
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. Notes:

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42
- for details. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes.
- The design, manufacturing process, and specifications of this filter are 5.
- subject to change.

 Either Port 1 or Port 2 may be used for either input or output in the design.

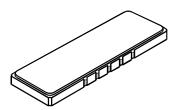
 However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per 6. the circuit design.
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SMP-87 Case

10-Terminal Ceramic Surface-Mount Case 22.1 x 8 mm Nominal Footprint



Case Dimensions							
Dimension	mm				Inches		
	Min	Nom	Max	Min	Nom	Max	
Α	21.90	22.10	22.40	0.862	0.870	0.882	
В	7.80	8.00	8.30	0.307	0.315	0.327	
С		1.78	2.00		0.070	0.079	
D		2.29			0.090		
E		1.02			0.040		
Н		1.0			0.039		
M		4.83			0.190		
N		2.41			0.095		
Р		1.905			0.075		

Materials				
Solder Pad Termination	Au plating 30 - 60 μ inches (76.2-152 μ m) over 80-200 μ inches (203-508 μ m) Ni.			
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 µinches Thick			
Body	Al ₂ O ₃ Ceramic			
Pb Free				

Electrical Connections				
	Connection	Terminals		
Port 1	Input or Return	10		
	Return or Input	1		
Port 2	Output or Return	5		
	Return or Output	6		
	Ground	All others		
Single E	Ended Operation	Return is ground		
Differen	tial Operation	Return is hot		

